

Channel Model Simulations for 112Gbps Backplane Applications

**IEEE 802.3 100GEL Study Group
Ad Hoc**

Geoff Zhang, Xilinx

Feb. 26, 2018

Outline

- ❑ Introduction
- ❑ Simulation setup description
- ❑ Group-1: “Channel Simulations for 112G Backplane Analysis”
 1. Orthogonal Backplane Channels and xtalk
 2. Cabled Backplane Channels and xtalk
- ❑ Group-2: “Initial Host Backplane Channel Models & Development Plans”
 1. Backplane with 2 connectors, 30dB, 85ohm nominal impedance
 2. Backplane with 2 connectors, 30dB, 85ohm high-low-high impedance
 3. Backplane with 2 connectors, 30dB, 85ohm low-high-low impedance
- ❑ Comparison of two groups of channel models
- ❑ Summary and conclusions

Introduction

- ❑ Objective: define a single-lane 100 Gb/s PHY for operation over electrical backplanes supporting an insertion loss \leq TBD dB at TBD GHz (*28GHz for 112Gbps PAM4 signaling*)
- ❑ Link models for the simulation are downloaded from
<http://www.ieee802.org/3/100GEL/public/tools/index.html>
- ❑ Specifically, backplane channel models from the following two groups are used

Initial Host Backplane Channel Models & Development Plans

- [Backplane with 2 connectors, 30dB, 85ohm nominal impedance](#)
- [Backplane with 2 connectors, 30dB, 85ohm high-low-high impedance](#)
- [Backplane with 2 connectors, 30dB, 85ohm low-high-low impedance](#)

19-Jan-2018

Howard Heck

Intel

Group-2 channels

Channel Simulations for 112G Backplane Analysis

- [Orthogonal Backplane Channels and xtalk](#)
- [Cabled Backplane Channels and xtalk](#)

19-Jan-2018

Nathan Tracy

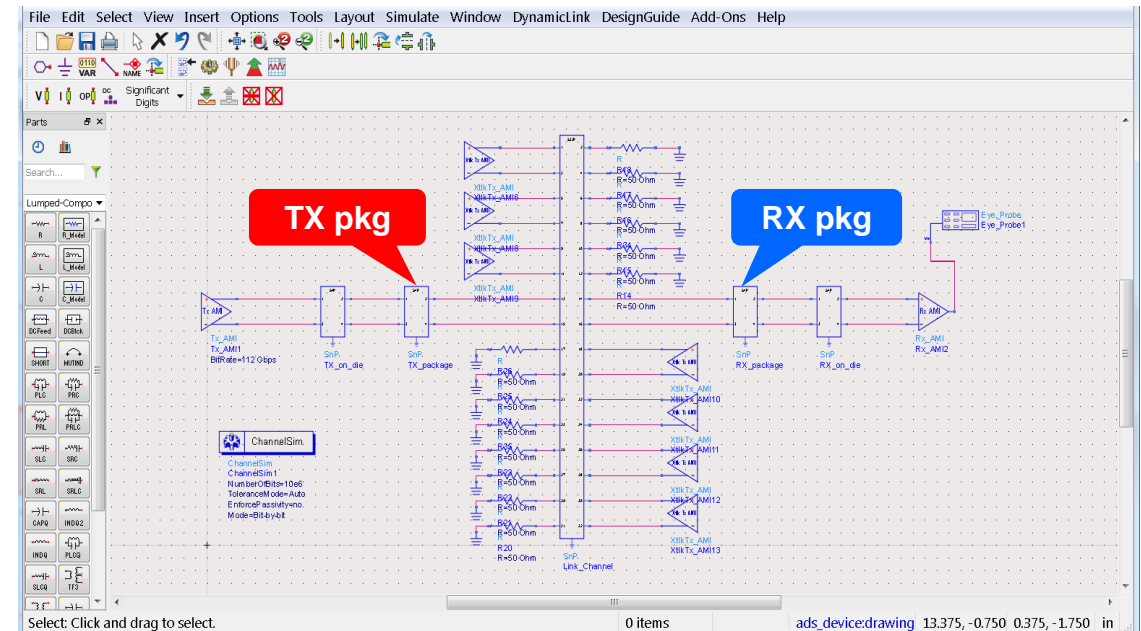
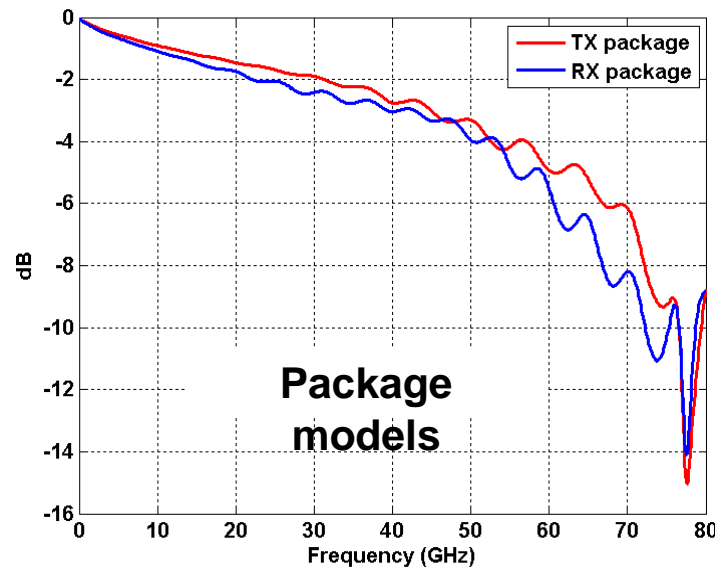
TE Connectivity

Group-1 channels

- ❑ The simulation model
 - ❖ The IBIS-AMI model is based on Xilinx 112G-PAM4 SerDes design in 16nm
- ❑ The simulation platform is the Keysight Advanced Design System (ADS)

Simulation Setup in ADS

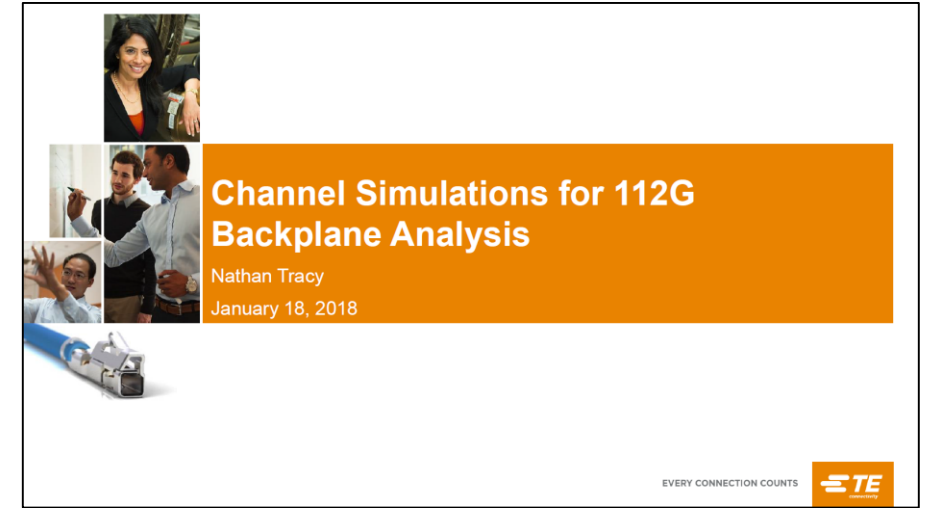
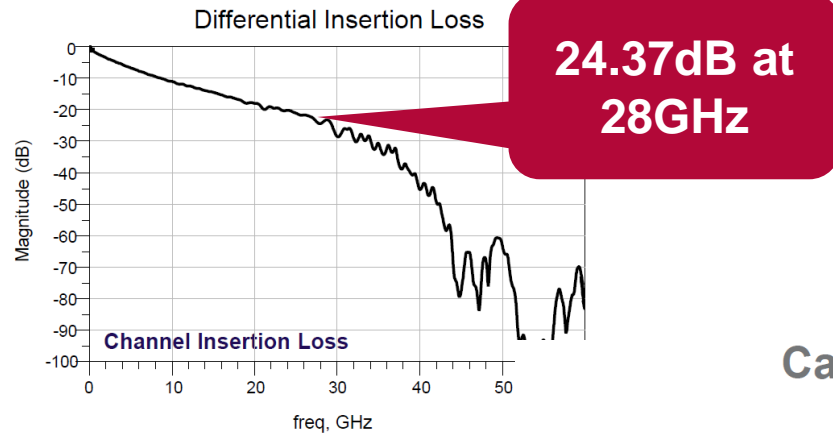
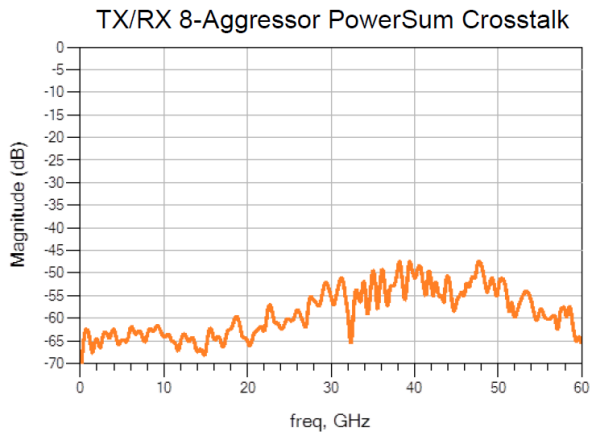
- ❑ The IBIS-AMI model (TT corner) for 112Gbps/PAM4 is simulated in ADS
 - ❖ An example of the ADS setup is shown below, with 1 THRU, 3 NEXT and 4 FEXT (reconstructed .32p model)
- ❑ Victim channel TX is set to 920mVdpp; a 3-tap FIR for de-emphasis whose settings are manually set
- ❑ Aggressors' TX output swing is set to 1000mVdpp, without de-emphasis applied
- ❑ RX side equalizer (CTLE, AGC, DSP) and CDR parameter values are all adaptively tuned
- ❑ Impairments (jitter, noise, nonlinearity, etc.) are either set as AMI parameters or included in the model
- ❑ Data pattern: PRBS23 with Gray coding (2M symbols for convergence and 10M for post-processing)
- ❑ The package models are shown below



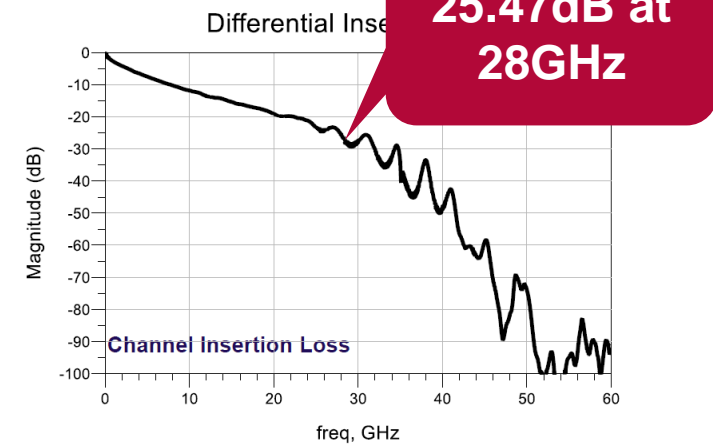
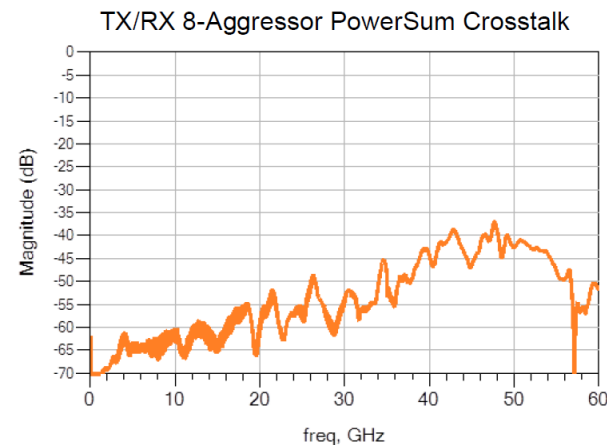
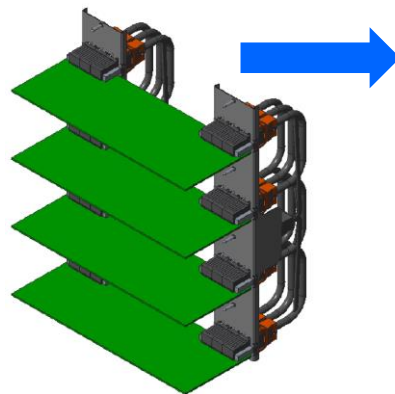
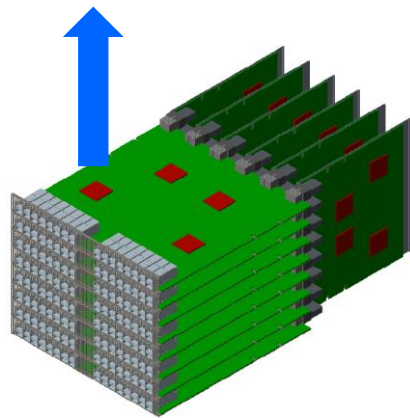
Channel Model Group-1

- Full description of the two channel models are provided in the document by Nathan Tracy

Orthogonal Backplane Channel Results



Cabled Backplane Channel Results



Simulation Results for Group-1

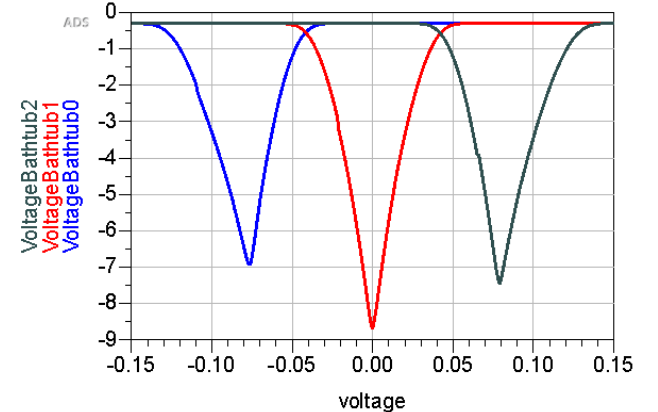
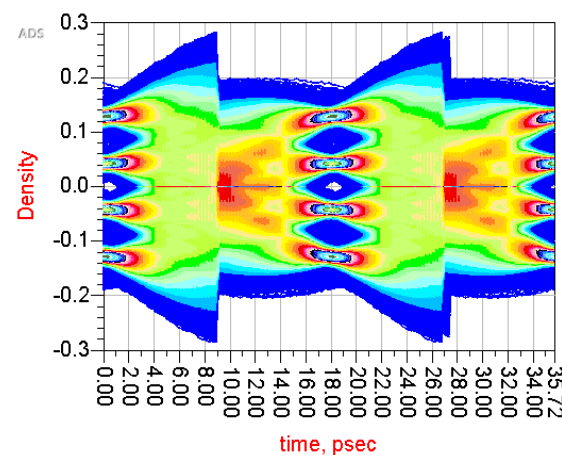
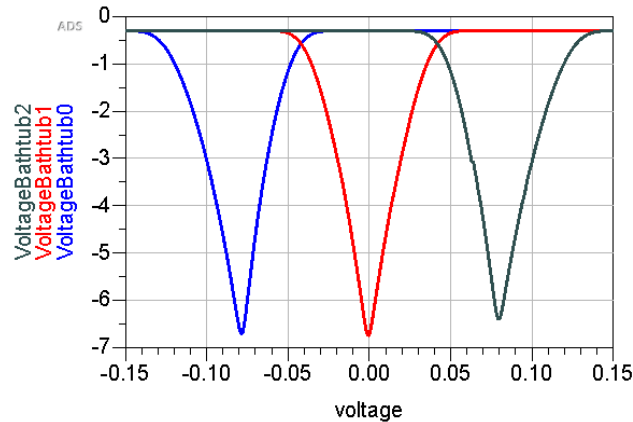
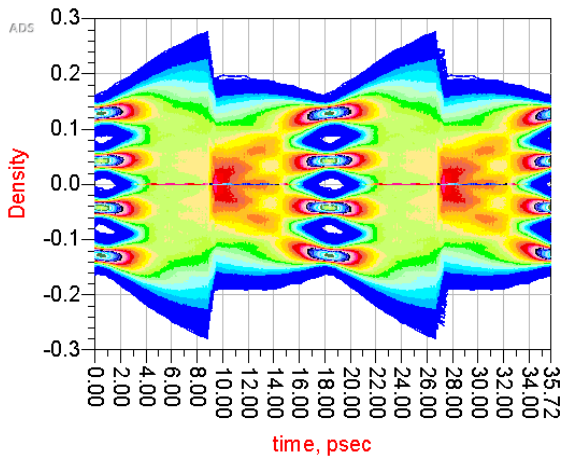
❑ Simulated link performance is summarized in the table

❖ With TX FIR setting perturbations, link performance pretty much remained comparable

TX 3-tap FIR settings	[-0.075, 0.75, -0.175]	[-0.125, 0.75, -0.125]	[-0.175, 0.75, -0.075]
Orthogonal Backplane	8.22e-8	2.27e-7	1.94e-7
Cabled Backplane	3.11e-7	7.85e-8	3.51e-7

❖ The eye diagrams at the data slicers and voltage bathtub curves for the orthogonal backplane channel with TX FIR = [-0.125, 0.75, -0.125] are shown below

- Left: PRBS23 with 8M symbols (more than one complete cycle of the PRBS pattern)
- Right: PRBS31 with 50M symbols (<2.33% of one complete cycle) – performance degradation is acceptable



Channel Model Group-2

- Full description of the models for the 3 channels are provided in the document by Howard Heck

Initial Host Backplane Channel Models & Development Plans

Howard Heck, Intel
January 2018 Interim Meeting
IEEE 802.3 100Gb/s per Lane Electrical Study Group

IEEE 802.3 100Gb/s per Lane Electrical Study Group

Compute Node (CN) Switch

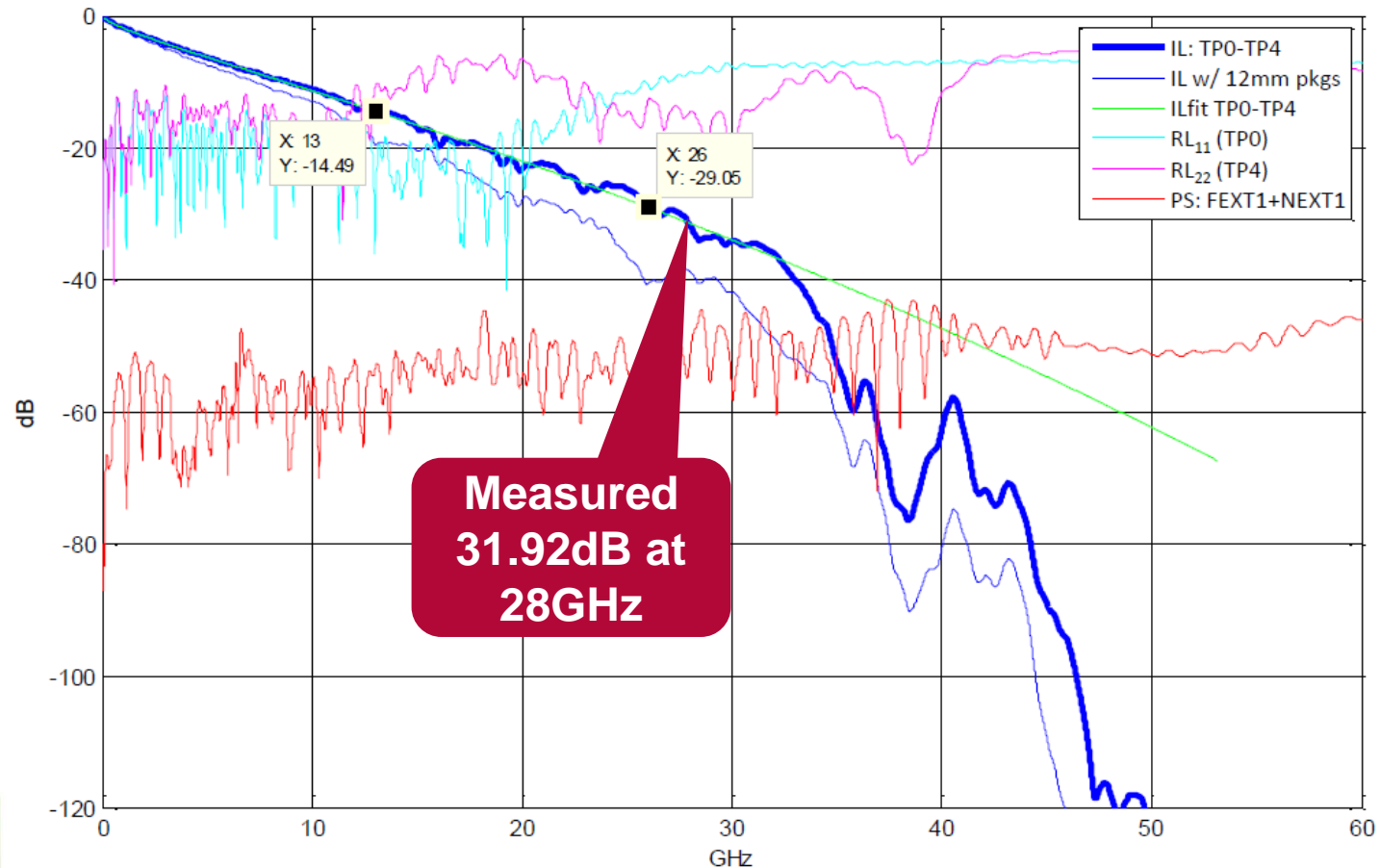
Tx Rx

Vias

- 1S/2G equivalent
- Bottom pad removed
- 10 mil stub

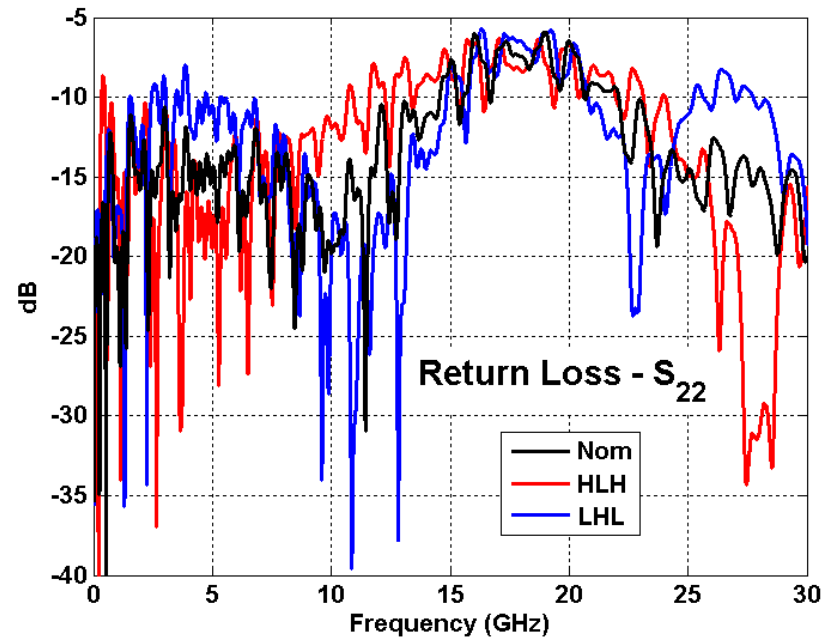
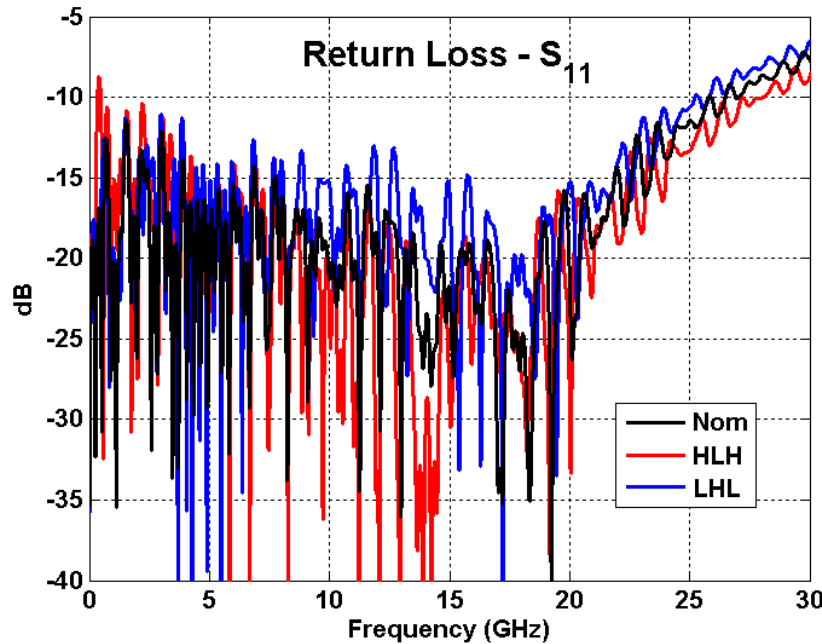
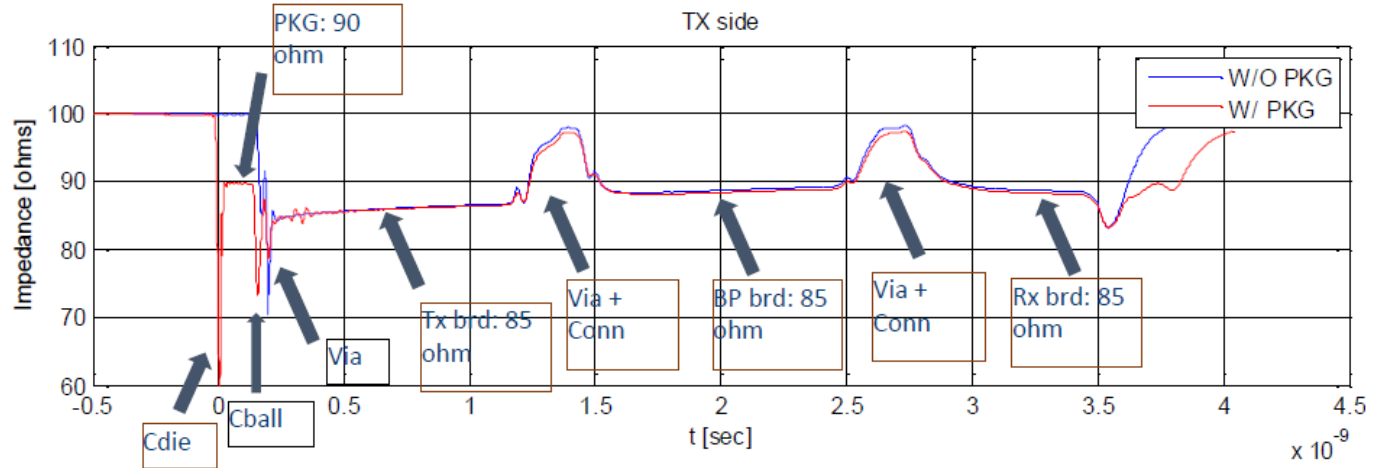
All boards 0.093" thick

Backplane (BP)



Channel Model Group-2 (Con't)

- In Group-2 the impedances of TX board, backplane, and RX board are varied to form Nom, HLH, and LHL
 - ❖ Insertion losses are almost the same
 - ❖ Return losses are very different

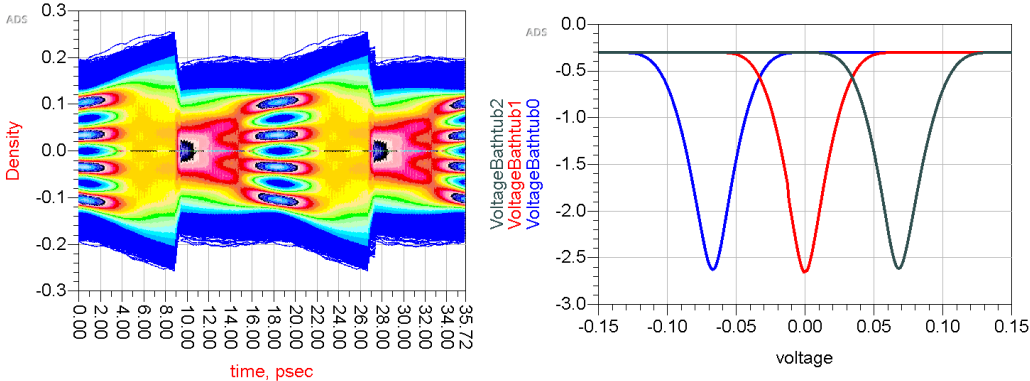


Simulation Results for Group-2

❑ Simulated link performance is summarized in the table

Channels with full crosstalk	heck_100GEL_85ohm_hlh_01_011718	heck_100GEL_85ohm_lhl_01_011718	heck_100GEL_85ohm_nom_01_011718
[-0.075, 0.75, -0.175]	3.22e-3	3.31e-3	3.21e-3
[-0.125, 0.75, -0.125]	2.81e-3	3.11e-3	2.92e-3
[-0.175, 0.75, -0.075]	2.18e-3	2.43e-3	2.07e-3

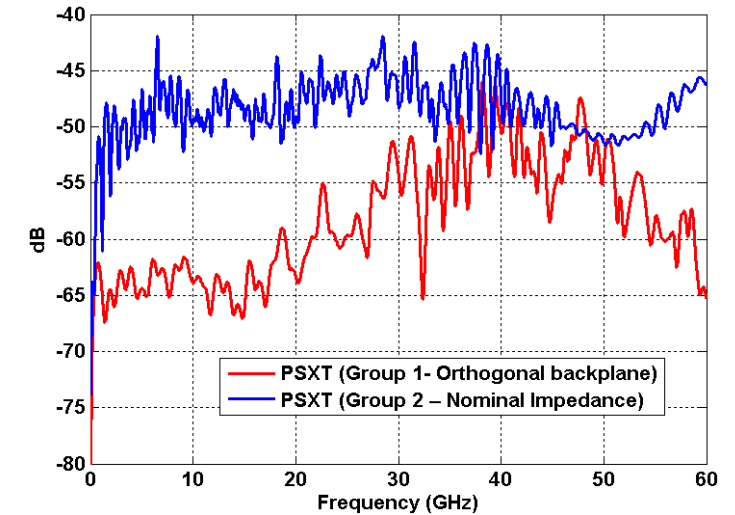
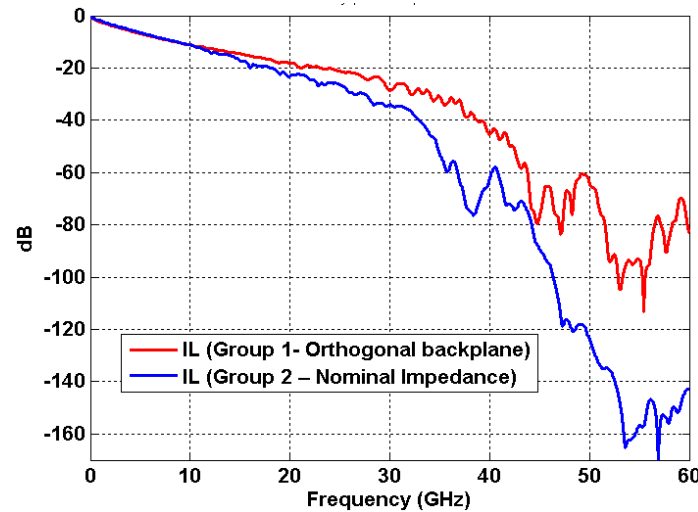
- ❖ It is seen that link channels in Group-2 performed much worse than those in Group-1
 - Since the 3 channels performed similarly, impedance variation did not seem to be the main cause for link performance degradation comparing with Group-1
- ❖ The BER performance is again not a strong function of TX FIR settings, within a certain range



Eye diagram and voltage bathtubs for “Nom” and FIR = [-0.125, 0.75, -0.125]

Comparison of two groups of models

- Taking one link channel from each group for a quick comparison
 - ❖ Group-1 has ~7dB less insertion loss at 28GHz than that in Group-2
 - ❖ Group-1 also has >10dB less aggregated crosstalk up to 30GHz
- With TX FIR fixed at [-0.125, 0.75, -0.125], the following sims are performed for better understanding of the differences



- ❖ Crosstalk is one of the dominant factors; by using the aggressor channels from Group-1, the Group-2 link performance improved by ~1.5 orders; while Group-1 channel BER increased by about 2 orders by using the crosstalk aggressor channels from Group-2
- ❖ Group-2 THRU channel also needs to be improved, as even without crosstalk, its performance is approximately 2 orders worse than Group-1 links with crosstalk

Simulation Configurations	Intrinsic setup	Crosstalk from the other Group
Group-1: Orthogonal Backplane	2.27e-7	1.10e-5
Group-2: heck_100GEL_85ohm_nom_01_011718	2.42e-3	9.84e-5
	5.35e-5 (without crosstalk)	

Extending Group-1 channel losses

- Extending the channel insertion loss, using the orthogonal channel in Group-1 as an example, by cascading the channel with a small piece of PCB
 - ❖ The crosstalk to the receive input is not changed
 - ❖ It is seen that the insertion loss can be extended to 30dB ball to ball for the channels in Group 1 with good margin

Ball-to-Ball IL (dB)	24.37	26.26	28.06	29.82	31.66	33.45
Simulated BER	2.27e-7	3.84e-7	1.81e-6	5.93e-6	3.74e-5	1.45e-4

- For the case 31.66dB with crosstalk, the simulated BER is 3.74e-5
 - ❖ The channel in Group-2 31.92dB; with the same crosstalk from Group-1, the simulated BER is 9.84e-5

Summary and Conclusions

- ❑ Two groups of channel models have been simulated at 112Gbps for PAM4 signaling
- ❑ Group-1 channels showed pretty good performance and robustness
 - ❖ There is not much difference in terms of the final BER between the orthogonal backplane and the cabled backplane configurations
- ❑ Group-1 outperformed Group-2 by about 4 order in the simulated BER
 - ❖ It is interesting to observe that the 3 variations in impedance profiles did not cause much BER difference
 - This is believed to be SerDes receiver architecture dependent
 - ❖ It is obvious that Group-2 channels need to reduce the amount of crosstalk coupling
 - ❖ It would be good if the channel insertion loss can be reduced to 30dB ball-to-ball
- ❑ With the package models used, it is concluded that, as long as the crosstalk is well controlled like the links in Group-1, the LR spec can be defined at 35dB bump-to-bump